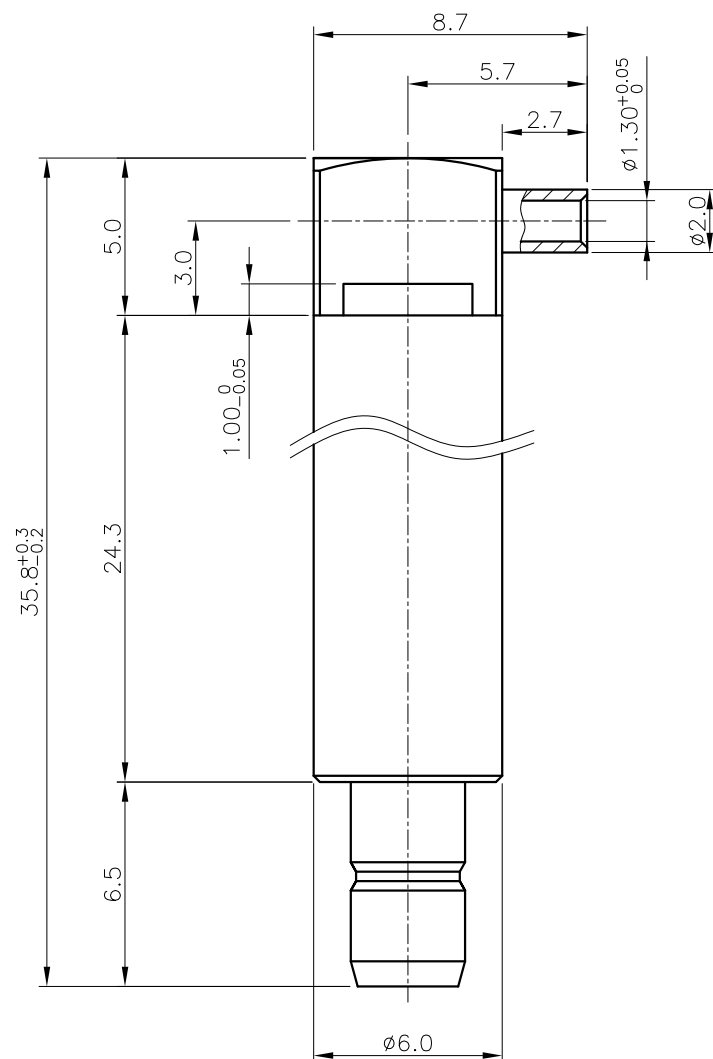
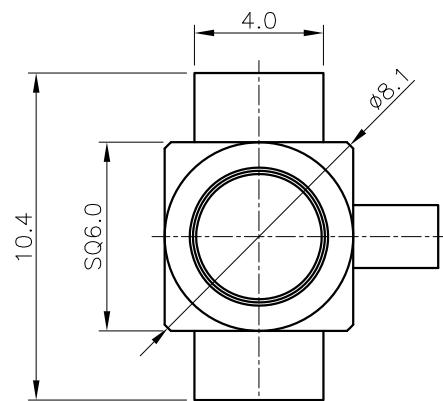


A

B

C

D



REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	C.K.KIM	I.C.KIM	2016.05.26.

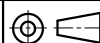
A

B

C

D

6	COVER	1	MBsBD C3604BD-F	Nickel Plate (3μm)	DCO00017-5/4
5	INSULATOR	1	TEFLON		DIN02033-N/1
4	INSULATOR	1	TEFLON		DIN02745-N/1
3	INSULATOR	1	TEFLON		DIN02032-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate (0.4μm)	DCT03677-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate (5μm)	DBD04146-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2016. 05. 26.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL _____		CHECKED BY H.J.LEE	TITLE SMB50 CABLE JL 47 파노라마		
		DRAWN BY C.K.KIM			
FINISH _____	SCALE 4/1	UNIT mm		A4	DWG NO. CN03593-7/1
				REVISION I R	SHEET 1 of 1